Interfacing the DP8422A to the 68000-16 (Zero Wait State Burst Mode Access)

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INTRODUCTION

This application note describes interfacing the DP8422A DRAM controller (also applicable to DP8420A/21A) to the 68000 (16 MHz) with slower memories. This design is based upon burst mode access by holding $\overline{RAS}$ low and toggling $\overline{CAS}$. It is assumed that the user is familiar with the DP8422A and 68000 mode operations.

DESIGN DESCRIPTION

This design consists of the DP8422A DRAM controller, a PAL (20R4D), and a page detector (ALS6311). This design accommodates four banks of DRAM, each bank being 16 bits in width, giving maximum memory capacity of either 2 Mbytes (using 256k x 4 light load DRAMs) or 8 Mbytes (using 1M x 1 DRAMs). The schematic diagram of interfacing DP8422A to the 68000 is shown in *Figure 1*. The DP8422A is operated in Mode 1. An access cycle begins when the 68000 places a valid address on the address bus and asserts the Address Strobe ($\overline{AS}$) if a refresh or Port B access (DP8422A only) is not in progress. The proper $\overline{RAS}$ and $\overline{CAS}$ will be asserted respectively, depending upon programming bits C6, C5, and C4 for $\overline{RAS}$ and $\overline{CAS}$ configuration after guaranteeing the programmed value of row address hold time and the column address setup time.

The High Speed Access ($\overline{HSA}$) output signal of page detector indicates whether the current access is in the same page as previous access or not. $\overline{ADS}$ (AREQ) is kept low if the current access is in the page, otherwise $\overline{ADS}$ ($\overline{AREQ}$) will be forced to go high to terminate the burst access. Internal refresh logic automatically generates refresh request every 15 μs. Since the 256k x 4 DRAM data input and output signals can be controlled by the Output Enable ($\overline{OE}$).

Transceivers (F245) could be eliminated from this design if 256k x 4 DRAM light load DRAM were used. The timing diagrams are shown in *Figure 2* and *Figure 3*.

DP8422A PROGRAMMING BITS

u = user defined

Programming Bits		Description
R0,R1	= 0,1	$\overline{RAS}$ high and low times
R2,R3	= u,u	$\overline{DTACK}$ generation mode for nonburst access
R4,R5	= u,u	$\overline{DTACK}$ generation mode for burst access
R6	= 0	Add wait states if $\overline{WAITIN}$ is low
R7	= 1	$\overline{DTACK}$ mode select
R8	= 1	Noninterleave mode
R9	= u	All $\overline{RAS}$'s or staggered refresh select
C0,C1,C2	= 0,1,0	Refresh clock divisor select
C3	= 0	Refresh clock divider select
C4,C5,C6	= u,u,u	$\overline{RAS}$ and $\overline{CAS}$ configuration mode
C7	= 1	tASC mode select
C8	= 1	tRAH mode select
C9	= u	Delay $\overline{CAS}$ during write access mode select
B0	= 1	Fall through mode
B1	= 1	Mode 1 access
$\overline{ECAS0}$	= 1	Extend $\overline{CAS}$ and refresh request

DESIGN TIMING PARAMETERS

Timing parameters are referenced to the numbers shown in the DP8422A data sheet timing parameters. Numbered times starting with a "$" refer to DP8422A timing parameters. Numbered times starting with a "#" refer to 68000 timing parameters.

16 MHz Tcp = 62.5 ns

$400b: $\overline{ADS}$ asserted setup to CLK

Tcp − PAL tCLK max.
= 62.5 ns − 8 ns
= 54.5 ns

$401: $\overline{CS}$ setup to $\overline{ADS}$ asserted

2 Tcp − #6 $\overline{CLK}$ to Address valid − PAL tp max.
= 125 ns − 55 ns − 10 ns
= 60 ns

#47: $\overline{DTACK}$ (68000) low setup to CLK low

Tcp − $18 CLK to $\overline{DTACK}$ (DP8422A) asserted − PAL tp max.
= 62.5 ns − 28 ns − 10 ns
= 24.5 ns (DP8422A-25)
= 62.5 ns − 33 ns − 10 ns
= 19.5 ns (DP8422A-20)

I. LIGHT LOAD TIMING

tRAC (nonburst access):

3 Tcp − PAL tCLK max. − $402 $\overline{ADS}$ low to $\overline{RAS}$ low − #27 data setup − F245 Transceiver tp max.
= 187.5 ns − 8 ns − 25 ns − 7 ns − 6 ns
= 141.5 ns (DP8422A-25)
= 187.5 ns − 8 ns − 30 ns − 7 ns − 6 ns
= 136.5 ns (DP8422A-20)

tCAC (nonburst access):

3 Tcp − PAL tCLK max. − $403a $\overline{ADS}$ low to $\overline{CAS}$ low − #27 data setup − F245 Transceiver tp max.
= 187.5 ns − 8 ns − 75 ns − 7 ns − 6 ns
= 91.5 ns (DP8422A-25)
= 187.5 ns − 8 ns − 86 ns − 7 ns − 6 ns
= 80.5 ns (DP8422A-20)

tAA (nonburst access):

3 Tcp − PAL tCLK max. − $417 $\overline{ADS}$ low to Column Address valid − #27 data setup − F245 Transceiver tp max.
= 187.5 ns − 8 ns − 69 ns − 7 ns − 6 ns
= 97.5 ns (DP8422A-25)
= 187.5 ns − 8 ns − 83 ns − 7 ns − 6 ns
= 83.5 ns (DP8422A-20)

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tCAC (burst access):

2.5 Tcp − #9 $\overline{CLK}$ high to $\overline{DS}$ low max. − PAL tp max. − $14 $\overline{ECAS}$ low to $\overline{CAS}$ low max. − #27 data setup − F245 Transceiver tp max.

= 156 ns − 40 ns − 10 ns − 20 ns − 7 − 6 ns

= 73 ns (DP8422A-25)

= 156 ns − 40 ns − 10 ns − 23 ns − 7 ns − 6 ns

= 70 ns (DP8422A-20)

tAA (burst access):

3 Tcp − #6 $\overline{CLK}$ low to Address valid max. − $26 Address valid to Q max. − #27 data setup − F245 Transceiver tp max.

= 187.5 ns − 5 ns − 26 ns − 7 ns − 6 ns

= 98.5 ns (DP8422A-25)

= 187.5 ns − 5 ns − 29 ns − 7 ns − 6 ns

= 95.5 ns (DP8422A-20)

II. HEAVY LOAD TIMING

tRAC (nonburst access):

3 Tcp − PAL tCLK max. − $402 $\overline{ADS}$ low to $\overline{RAS}$ low − #27 data setup − F245 Transceiver tp max.

= 187.5 ns − 8 ns − 29 ns − 7 ns − 6 ns

= 137.5 ns (DP8422A-25)

= 187.5 ns − 8 ns − 35 ns − 7 ns − 6 ns

= 131.5 ns (DP8422A-20)

tCAC (nonburst access):

3 Tcp − PAL tCLK max. − $403a $\overline{ADS}$ low to $\overline{CAS}$ low − #27 data setup − F245 Transceiver tp max.

= 187.5 ns − 8 ns − 82 ns − 7 ns − 6 ns

= 84.5 ns (DP8422A-25)

= 187.5 ns − 8 ns − 94 ns − 7 ns − 6 ns

= 72.5 ns (DP8422A-20)

tAA (nonburst access):

3 Tcp − PAL tCLK max. − $417 $\overline{ADS}$ low to Column Address valid − #27 data setup − F245 Transceiver tp max.

= 187.5 ns − 8 ns − 78 ns − 7 ns − 6 ns

= 88.5 ns (DP8422A-25)

= 187.5 ns − 8 ns − 92 ns − 7 ns − 6 ns

= 74.5 ns (DP8422A-20)

tCAC (burst access):

2.5 Tcp − #9 $\overline{CLK}$ high to $\overline{DS}$ low max. − PAL tp max. − $14 $\overline{ECAS}$ low to $\overline{CAS}$ low max. − #27 data setup − F245 Transceiver tp max.

= 156 ns − 40 ns − 10 ns − 27 ns − 7 ns − 6 ns

= 66 ns (DP8422A-25)

= 156 ns − 40 ns − 10 ns − 31 ns − 7 ns − 6 ns

= 62 ns (DP8422A-20)

tAA (burst access):

3 Tcp − #6 $\overline{CLK}$ low to Address valid max. − $26 Address valid to Q max. − #27 data setup − F245 Transceiver tp max.

= 187.5 ns − 5 ns − 35 ns − 7 ns − 6 ns

= 89.5 ns (DP8422A-25)

= 187.5 ns − 5 ns − 38 ns − 7 ns − 6 ns

= 86.5 ns (DP8422A-20)

68KPAL (PAL20R4D) EQUATIONS

The Boolean entry operators are listed as:

":="	Replaced by (after clock)
"="	Equality
"*"	AND
"+"	OR
"/"	Complement
"~"	Active low

The brief explanation of PAL output signals

CS~	This combinational output signal is Chip Select.
CSD~	This sequential output signal is Chip Select Delayed by one clock.
ADS~	This sequential output signal is Address Strobe (also used as an Access Request, $\overline{AREQ}$, to DP8422A).
READY~	This combinational output signal is Data Ready.
ECASU~	This combinational output signal is to select upper byte.
ECASL~	This combinational output signal is to select lower byte.

Inputs: CLK, A21, A22, FC2, FC1, FC0, UDS~, LSD~, RFRQ~, AS~, DTACK~, HSA~

Outputs: /CS~ = /A21*/A22*/FC2*/FC1*FC0 +
/A21*/A22*/FC2*FC1*/FC0+
/A21*/A22*FC2*/FC1*FC0+
/A21*/A22*FC2*FC1*/FC0

/CSD~ := /CS~

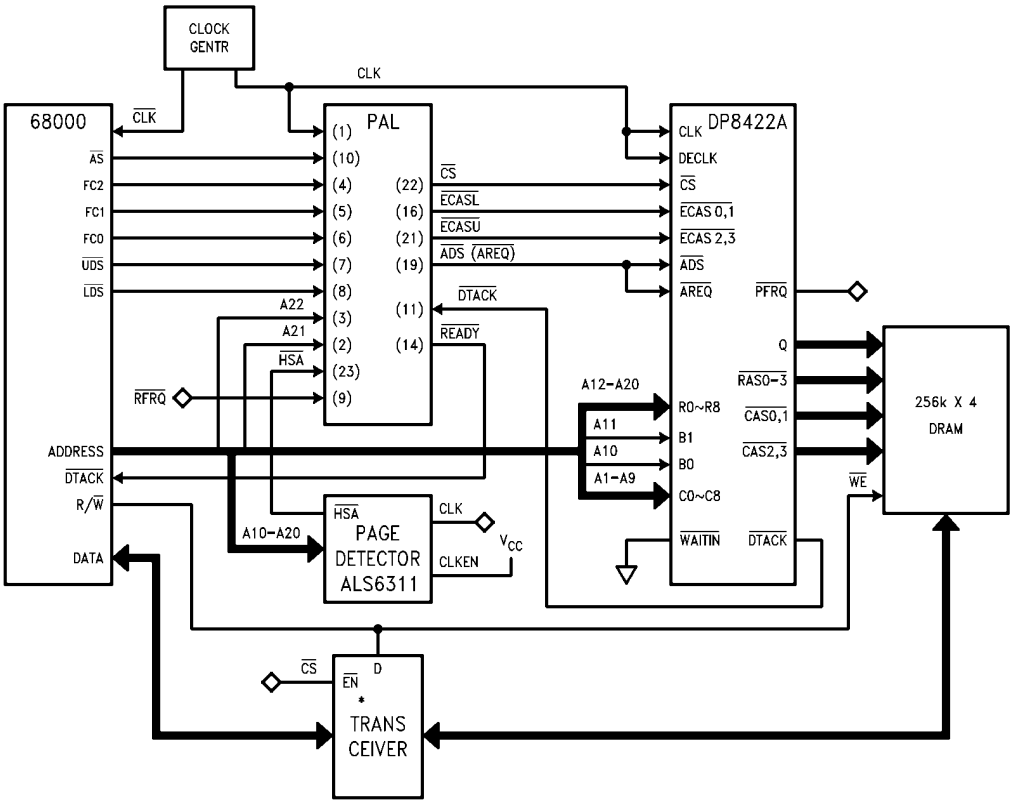
/ADS~ := /HSA~*/CSD~*RFRQ~ +
/AS~*/RFRQ~

/READY~ = /DTACK~*/AS~

/ECASU~ = /ADS~*/UDS~*/CSD~
*/HSA~

/ECASL~ = /ADS~*/LDS~*/CSD~
*/HSA~

Note: Address inputs such as A21 and A22, are system dependent.



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*Transceivers could be eliminated from this design.

FIGURE 1.1 Schematic Diagram of Interfacing DP8422A/68000 Burst Access to 256k x 4 DRAM

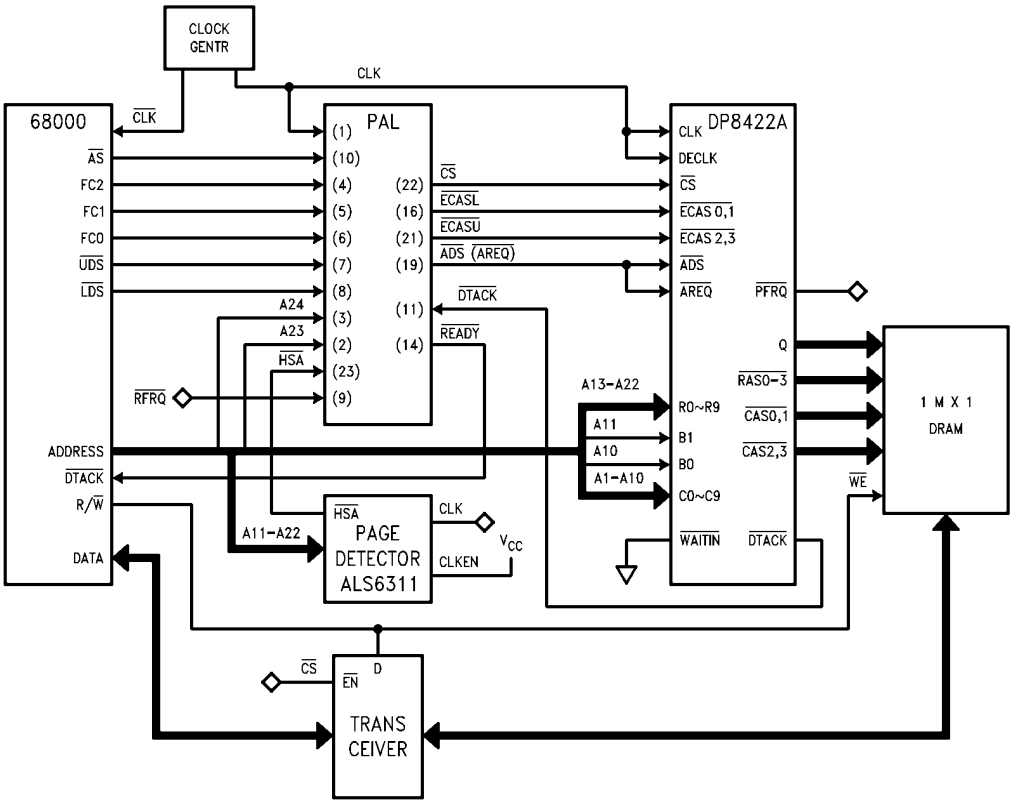

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FIGURE 1.2 Schematic Diagram of Interfacing DP8422A/68000 Burst Access to 1M x 1 DRAM

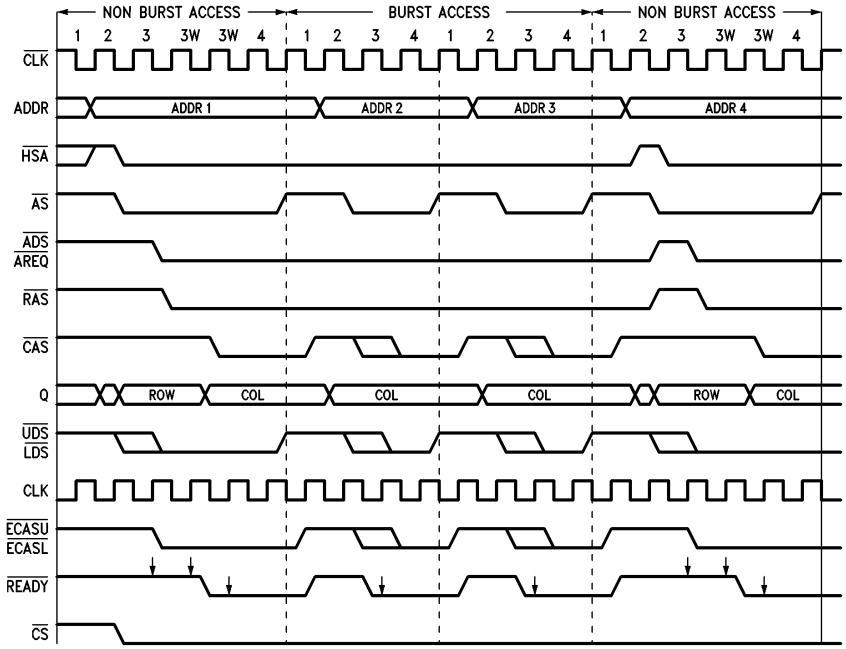

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FIGURE 2. Timing Diagram of Burst and Nonburst Access

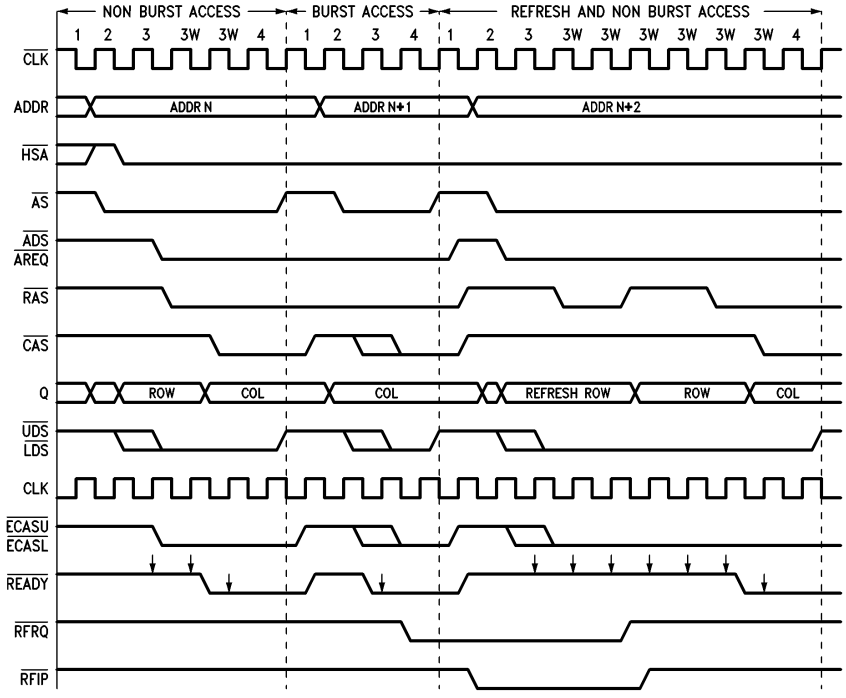

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FIGURE 3. Timing Diagram of Refresh, Burst and Nonburst Access

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